

1 PROGRAMMABLE CURRENT SOURCE
2 AND METHODS OF USE

3
4 Field of the Invention

5
6 This invention relates to programmable current sources for
7 use in electronic devices.

8
9 More particularly, the present invention relates to
10 programmable current sources that provide multiple current
11 source inputs to a plurality of similar circuits.

12
13
14 Background of the Invention

15
16 Multiple programmable current sources are generally
17 fabricated as an integrated circuit chip designed to accept
18 data and control signals as inputs and deliver constant,
19 electric currents as outputs to other electronic circuits, such
20 as light-emissive displays and other systems requiring
21 multiple, programmable current sources as inputs. Using light-
22 emissive displays as an example, such displays generally
23 consist of a matrix of rows and columns of pixels (from
24 hundreds to thousands, depending upon the size and definition
25 of the display). The rows are generally designated 0 through R

1 and the columns are designated 0 through N. It should be
2 understood that rows and columns can be interchanged throughout
3 this disclosure and no use of the terms 'rows' or 'columns' is
4 intended in any way to limit the structure or the scope of the
5 invention.

6
7 A complete screen is usually produced by cycling the rows
8 periodically from 0 to R and supplying to each column an amount
9 of current required to produce the desired luminance in each
10 pixel in the activated row. Thus, for example, when row 0 is
11 activated a current is supplied to each column 0 through N,
12 when row 1 is activated a different current (possibly) is
13 supplied to each column 0 through N, etc. Since only one row
14 of pixels is activated at a time, only the pixels in that row
15 are driven to emit light by the current applied to the columns.
16 The current applied to each column generally has a plurality of
17 steps or levels that cause the light emissive device in a pixel
18 to emit light in an equal number of steps or levels. During
19 the process of addressing each pixel in a screen, it is
20 desirable for each pixel to have the same brightness or
21 luminance for each step or level.

22
23 In many prior art constant current sources a skew or
24 mismatch is exhibited due to intrinsic device parameters in the
25 constant current source circuitry. These skews or mismatches
26 are undesirable and can occur for any type of transistor

1 topology, including but not limited to silicon based NMOS or
2 PMOS transistors. Also, while many different implementations
3 of light-emissive displays (and other systems requiring
4 multiple, programmable current sources) are possible, in most
5 instances the current must flow through a plurality of
6 components (e.g. transistors, capacitances, etc.) connected in
7 series. The intrinsic mismatch between these series components
8 and subsequent series components (e.g. between pixels in a
9 column) causes current variations between the currents flowing
10 in different columns, which produce undesired variations in
11 luminance of the pixels.

12
13 It would be highly advantageous, therefore, to remedy the
14 foregoing and other deficiencies inherent in the prior art.

15
16 Accordingly, it is an object of the present invention to
17 provide a new and improved programmable current source.

18
19 Another object of the invention is to provide a new and
20 improved programmable current source that provides matched
21 currents at multiple outputs.

22
23 And another object of the invention is to provide a new
24 and improved programmable current source and a variety of
25 calibration techniques that provides matched currents at
26 multiple outputs.

1 Still another object of the present invention is to
2 provide a new and improved programmable current source that can
3 be easily incorporated with virtually any circuitry requiring
4 multiple constant current outputs.

5

6 Yet another object of the invention is to provide a new
7 and improved programmable current source that is relatively
8 easy and inexpensive to integrate on a single chip.

Summary of the Invention

Briefly, to achieve the desired objects of the instant invention in accordance with a preferred embodiment thereof, provided is a programmable multiple current source including a plurality of current source circuits each including current level data storage circuitry. A current level data input terminal and a control input terminal are connected to each of the plurality of current source circuits to supply current level data to the storage circuitry in each of the plurality of current source circuits. Peak detector and storage circuitry is coupled to each of the output terminals of the plurality of current source circuits and includes a peak signal output terminal. Each associated current source circuit of the plurality of current source circuits includes a master digital-to-analog converter coupled to the current level data storage circuitry of the associated current source circuit, a driver circuit having an input coupled to the master digital-to-analog converter and an output coupled to the output terminal of the associated current source circuit, comparator and storage circuitry having a first input coupled to the peak signal output terminal of the peak detector and storage circuitry, a second input coupled to the output of the driver circuit, and an output, and current level adjustment circuitry coupled to the output of the comparator and storage circuitry and the input of the driver circuit.

1 The desired objects of the instant invention are further
2 realized in accordance with a preferred method of calibrating a
3 programmable multiple current source. The method includes a
4 step of providing a plurality of current source circuits each
5 including current level data storage circuitry, each of the
6 plurality of current source circuits including an output
7 terminal, and each of the plurality of current source circuits
8 being constructed to operate at a plurality of current levels
9 from a maximum current level to a minimum current level. The
10 method also includes a step of supplying current level data
11 representative of one current level in the plurality of current
12 levels to the current level data storage circuitry in each of
13 the plurality of current source circuits. Further steps in the
14 method include receiving a plurality of output signals, one
15 each representative of output current at each output terminal
16 of the plurality of current source circuits and sensing a peak
17 output signal in the plurality of received output signals,
18 comparing the output signal representative of output current at
19 each output terminal of the plurality of current source
20 circuits to the sensed peak output signal to determine a
21 difference and generating a plurality of adjustment signals,
22 one each representative of the difference for each of the
23 plurality of current source circuits, storing the plurality of
24 adjustment signals, one each for each of the plurality of
25 current source circuits, and using the stored plurality of
26 adjustment signals, one each for each of the plurality of

1 current source circuits, to adjust the output current at each
2 output terminal of the plurality of current source circuits so
3 that all of the plurality of current source circuits provide
4 substantially matching output currents.

5
6 In one specific use of the subject apparatus and method a
7 light-emissive display is provided with a plurality of pixels
8 arranged in an array of rows and columns and the plurality of
9 current source circuits are connected, one each, to each column
10 of the display.

Brief Description of the Drawings

The foregoing and further and more specific objects and advantages of the instant invention will become readily apparent to those skilled in the art from the following detailed description of a preferred embodiment thereof taken in conjunction with the drawings, in which:

FIG. 1 illustrates a programmable current source chip coupled to a system using multiple, programmable current source inputs;

FIGS. 2 and 3 illustrate typical constant current source circuits that exhibit a current skew problem;

FIG. 4 illustrates a typical example of the problem of providing matched currents at multiple outputs;

FIG. 5 is a general example of the use of a programmable current source that provides multiple matched currents in accordance with the present invention;

FIG. 6 is a schematic of a programmable current source chip in accordance with the present invention; and

1 FIG. 7 is a schematic of a specific embodiment of a
2 programmable current source chip in accordance with the present
3 invention.

Detailed Description of the Preferred Embodiment

Turning now to the drawings in which like reference characters indicate corresponding elements throughout the several views, attention is first directed to FIG. 1 which illustrates, generally, an electronic system 10 that includes a programmable current source integrated circuit chip 12 and an electronic circuit 14 connected to receive a plurality of currents N on a similar plurality of output leads 0 through N. Circuit 14 can be any circuit or application, such as a light emissive display, that requires multiple programmable current source inputs. Current source 12 accepts data and control signals on buses 16 and 18, respectively, and delivers programmed constant electric currents on output leads 0 through N to circuit 14. The problem that arises is that prior art constant current sources exhibit skew or mismatch due to intrinsic device parameters.

Referring additionally to FIG. 2, an example of a typical prior art constant current source 20 is illustrated. In source 20 a pair of PMOS transistors P1 and P2 are formed on a common chip and connected directly in parallel to conduct equal or matching currents. However, despite the transistors being the same size, because of intrinsic parametric differences introduced during fabrication the currents flowing through transistors P1 and P2 will not be equal. Referring additionally

1 to FIG. 3, an example of a typical prior art constant current
2 source 22 is illustrated. In source 22 a pair of NMOS
3 transistors N1 and N2 are formed on a common chip and the gates
4 are connected directly in parallel to a common source current
5 so that transistors N1 and N2 are expected to conduct equal or
6 matching currents. However, despite the transistors in both
7 cases being the same size (i.e. $P1=P2$, $N1=N2$), because of
8 intrinsic parametric differences introduced during fabrication
9 the currents flowing through transistors P1 and P2 or N1 and N2
10 will not be equal. The differences may be very small but in
11 an industry which must capitalize on the use of very small
12 currents, the differences between currents flowing in
13 transistors P1/P2 and N1/N2 can be a substantial problem.

14
15 Turning now to FIG. 4, a schematic diagram of an example
16 of a typical light emissive display 25 connected to a
17 programmable multiple current source 26 is illustrated. Light
18 emissive display 25 is represented by only three pixels in a
19 single row to simplify the example. It will be understood
20 however, that display 25 will generally include hundreds, or
21 even thousands, of similar pixels in each row and hundreds, or
22 even thousands, of rows. As can be seen in FIG. 4, each pixel
23 includes a plurality of thin film transistors (TFTs) and an
24 LED, or light emissive device. Current flowing from current
25 source 26 flows through any pixels activated by a voltage on
26 the lead V_{ROW} . Also, current flowing through any pixel must

1 flow through several components connected in series (e.g. TFT1₀
2 and TFT2₀) and the LED to a current return terminal. The
3 intrinsic mismatch between the series connected devices in each
4 pixel (e.g. the difference between the series circuit TFT1₀,
5 TFT2₀ and the LED and the series circuit TFT1_N, TFT2_N and the
6 LED) causes variations in the currents (in this specific
7 example I_{PIXEL(0)} and I_{PIXEL(N)}). These current variations cause
8 undesired variations in luminance of the pixels.

9
10 Turning now to FIG. 5, a simplified block diagram of a
11 programmable multiple current source 30 in accordance with the
12 present invention is illustrated in connection with a typical
13 light emissive display for purposes of illustration. In this
14 example, programmable multiple current source 30 provides
15 multiple (N) matched currents to a light emissive display 32
16 consisting of R rows and N columns of pixels. A controller
17 circuit or chip 34 sends data codes and data control signals to
18 current source 30 causing current source 30 to deliver N
19 matching current outputs to the N columns of display 32. A row
20 driver chip 36 delivers excitation voltage to each of the R
21 rows of display 32 in a regular cycle (i.e. row 0, row 1, etc.
22 through row R and then back to row 0) in response to timing or
23 control signals supplied by controller chip 34.

24
25 Referring additionally to FIG. 6, a more detailed
26 schematic of programmable multiple current source 30 is

1 illustrated. Multiple current source 30 includes a plurality
2 of current source circuits $40_{(0)}$ through $40_{(N)}$ each including
3 current level data storage circuitry. In this embodiment the
4 current level data storage circuitry in each associated current
5 source circuits $40_{(0)}$ through $40_{(N)}$ includes a register 42 and a
6 latching circuit 44. A current level data input terminal and
7 bus 46 and a control input terminal and bus 48 are connected to
8 each of the plurality of current source circuits $40_{(0)}$ through
9 $40_{(N)}$ to supply current level data to the storage. In this
10 example, current level data input terminal and bus 46 and
11 control input terminal and bus 48 are connected to controller
12 chip 34 (see FIG. 5). As will be understood by those skilled
13 in the art, bus 46 carries digital signals (current level data)
14 representative of a specific luminance (or driving current)
15 level for each pixel and bus 48 carries control signals that
16 direct the correct luminance signal to be stored in each
17 register 42 and latch 44 of the current source circuits $40_{(0)}$
18 through $40_{(N)}$.

19
20 For example, if light emissive display 32 is constructed
21 to operate with sixty four levels of luminance in each pixel,
22 bus 46 might have as few as six leads (it could include more
23 leads for other functions) to carry the digital code
24 representative of a specific one of the sixty four possible
25 levels. The code for each pixel of the N pixels would appear
26 in parallel on bus 46 and be clocked into the appropriate

1 register 42 by a timing signal on bus 48. In this example, a
2 first six bit current level signal is clocked into register 42
3 in current source circuit 40₍₀₎, a second six bit current level
4 signal is clocked into register 42 in current source circuit
5 40₍₁₎, and so on through register 42 in current source circuit
6 40_(N). Specific connections of bus 48 are not illustrated for
7 simplicity and an easier understanding of the inventive portion
8 of the system.

9
10 Each current source circuit 40₍₀₎ through 40_(N) includes a
11 master digital-to-analog converter 50 coupled to the current
12 level data storage circuitry of the associated current source
13 circuit. In each of the current source circuits, digital-to-
14 analog converter 50 receives the six bit digital signal (in
15 this example) from latch 44 and converts it to the appropriate
16 analog signal, which is then applied to a column driver circuit
17 52. The output of each of the N driver circuits 52 is applied
18 to an output terminal I₍₀₎ through I_(N) of the associated current
19 source circuit 40₍₀₎ through 40_(N). The outputs of all of the N
20 driver circuits 52 are also applied through N switches 54 to
21 the input of peak detector and storage circuitry, which in this
22 embodiment includes a peak detector 56 and a level shift
23 circuit 58. In this embodiment switches 54 are illustrated as
24 single-pole single-throw switches but it will be understood
25 that this is simply a schematic representation and some form of
26 semiconductor may be used so as to be integrated into the chip.

1 Each current source circuit $40_{(0)}$ through $40_{(N)}$ also
2 includes comparator and storage circuitry, which in this
3 embodiment includes a comparator 60 and some convenient form of
4 memory 62. Each comparator 60 includes an input connected to
5 an output of level shift circuit 58 for receiving a signal
6 representative of a peak signal. Each comparator 60 also
7 includes an input connected to driver circuit 52 of the
8 associated current source circuit for receiving an output
9 signal representative of the drive signal at the output $I_{(0)}$
10 through $I_{(N)}$ of the associated current source circuit.
11 Comparator 60 compares the two input signals and supplies a
12 signal representative of the difference to memory 62. An
13 oscillator 64 and counter 66 may optionally supply a signal to
14 an input of memory 62 for incrementing addresses in memory 62
15 or for converting the difference signal in comparator 60 to a
16 digital signal for convenient storage in memory 62, as will be
17 described in more detail presently.

18
19 An output signal from memory 62 is supplied to an
20 adjustment circuit 68, which supplies an analog compensation or
21 adjustment signal, in conjunction with the analog signal from
22 digital-to-analog converter 50, to the input of driver circuit
23 52. The analog adjustment signal is specifically generated to
24 bring the drive signal at the output of driver circuit 52, in
25 each of the current source circuits $40_{(0)}$ through $40_{(N)}$ into a
26 substantially matching level or state when the same current

1 level data input signal is applied. Generally, the adjustment
2 signal will change or adjust the input signal to driver circuit
3 52 a small amount or some convenient amount (e.g. a fraction of
4 a level or one complete level). In the preferred method (which
5 will be described presently), the adjusted output signal of
6 driver circuit 52 is again compared to the peak signal in
7 comparator 60 and a second adjustment is generated, if
8 necessary. The adjustment cycle is continued until the output
9 of driver circuit 52 matches the peak signal in comparator 60,
10 at which time the final adjustment signal is stored in
11 adjustment circuit 68 and comparator 60 latches memory 62 to
12 stop or deactivate the process. In some specific adjustment
13 methods, adjustment circuit 68 may use the digital current
14 level data signal stored in latch 44, and, accordingly, a
15 connection for that purpose is illustrated.

16
17 A variety of methods for adjusting the driver current at
18 the current outputs $I_{(0)}$ through $I_{(N)}$ of programmable multiple
19 current source 30 to achieve substantially matched currents are
20 possible. For convenience in understanding the present
21 invention and its operation, three potential methods of
22 adjustment are described below. Further, each of the methods
23 is performed during a calibration period that may be performed
24 at any convenient time, e.g. when the display is first turned
25 on, periodically (every half-hour, hour, etc.), or whenever a
26 change in the display is sensed. It will of course be

1 understood by those skilled in the art that modifications of
2 the described methods and other completely different methods
3 may be devised.

4
5 In a first method of adjusting or matching the driver
6 current at the current outputs $I_{(0)}$ through $I_{(N)}$, a calibration
7 period includes a calibration cycle performed for each row, row
8 0 through row R. In the first calibration cycle, a maximum
9 illumination level signal is applied by way of bus 46 to
10 register 42 in each of the current source circuits $40_{(0)}$ through
11 $40_{(N)}$ with row 0 of pixels activated. All N switches 54 are
12 closed sequentially so that all N outputs are applied
13 sequentially to peak detector 56 and the peak output is sensed.
14 The peak output is stored and simultaneously applied to each
15 comparator 60 in each current source circuit $40_{(0)}$ through $40_{(N)}$.
16 The comparison and adjustment cycle described above is
17 performed in each current source circuit $40_{(0)}$ through $40_{(N)}$
18 until the outputs of all current source circuit $40_{(0)}$ through
19 $40_{(N)}$ match at the maximum level with row 0 of pixels activated.
20 The final adjustment signal generated by adjust circuit 68 is
21 stored for use each time row 0 is activated.

22
23 A second calibration cycle is then performed with row 1
24 activated, a third calibration cycle is performed for row 2,
25 and so on through all R rows. In each cycle the final
26 adjustment signal is stored and used each time that row is

1 activated. Thus, R final adjustment signals are stored in each
2 of the N adjustment circuits 68 and applied during actual use
3 of display 32. In this method, it is assumed that the amount
4 of adjustment required at each level of illumination for each
5 pixel will be approximately the same. While a maximum level is
6 used throughout the calibration period, it will be understood
7 that any other level (e.g. one of the mid levels) could be used
8 to develop the amount of adjustment signal required for
9 matching all of the outputs.

10
11 In another method of adjusting or matching the driver
12 current at the current outputs $I_{(0)}$ through $I_{(N)}$, a calibration
13 period includes a calibration cycle performed for each row, row
14 0 through row R. In this method, during a calibration cycle, a
15 pre-selected list of specific level codes are cycled into each
16 register 42 in each of the current source circuits $40_{(0)}$ through
17 $40_{(N)}$ with row 0 of pixels activated. The specific level codes
18 could be, for example, 10000, 010000, 001000, 000100, 000010,
19 and 000001, assuming sixty four levels of luminance or drive
20 current. In this example, adjustment circuit 68 will usually
21 include a 6-bit priority encoder. An adjustment signal is
22 generated and stored in each of the N adjustment circuits 68,
23 as described above, for each of the six specific level codes.
24 A second calibration cycle is then performed with row 1
25 activated and so on through all R rows.

1 Once the calibration period is completed and display 32 is
2 in normal use, as each row in a screen is activated the level
3 input data cycled into each register 42, for the pixel in the
4 activated row, is provided to adjustment circuit 68.
5 Adjustment circuit 68 determines the most significant digit in
6 the level input data and supplies the adjustment signal that
7 conforms to that digit. For example, when the level input data
8 is 000100 adjustment circuit 68 supplies the adjustment signal
9 developed for specific level code 000100, when the level input
10 data is 000101 adjustment circuit 68 supplies the adjustment
11 signal developed for specific level codes 000100 and 000001,
12 when the level input data is 000111 adjustment circuit 68
13 supplies the adjustment signal developed for specific level
14 codes 000100, 000010, and 000001, etc.

15
16 In another method, every level is adjusted in every pixel.
17 That is, in a first adjustment cycle of an adjustment period,
18 an adjustment signal is developed and stored (as described
19 above) for each of the sixty three levels (skipping of course
20 the zero or off level) of current or luminance of the current
21 source circuits $40_{(0)}$ through $40_{(N)}$ with row 0 of pixels
22 activated. In a second adjustment cycle of the adjustment
23 period, an adjustment signal is developed and stored (as
24 described above) for each of the sixty three levels (skipping
25 of course the zero or off level) of current or luminance of the
26 current source circuits $40_{(0)}$ through $40_{(N)}$ with row 1 of pixels

1 activated. In this fashion an adjustment signal for each of
2 the sixty three levels is developed and stored for each pixel
3 in each row. Because of the inordinately large number of
4 adjustment signals (63 times R for each column in this example)
5 that must be stored in this method, it is not a preferred
6 method at this time.

7
8 Referring to FIG. 7, the preferred method of adjusting or
9 matching the driver current at the current outputs $I_{(0)}$ through
10 $I_{(N)}$, is illustrated. In FIG. 7, components that are similar to
11 components in FIG. 6 are designated with similar numbers having
12 a prime added to indicate the different embodiment. Also,
13 components described in conjunction with FIG. 6 will not be
14 further described unless additional or different functions are
15 performed. In this embodiment, adjustment circuit 68 is
16 replaced with a process block 68' and an adjustment digital-to-
17 analog converter 69', the output of which is added to the
18 output of digital-to-analog converter 50' by a summing circuit
19 67'. It should be noted that in this embodiment a voltage is
20 sensed at the output of driver 52' (even though schematically
21 it is connected to the current output) and supplied to
22 comparator 60'. Also, the output signal from level shift
23 circuit 58' is a voltage, since voltages are generally easier
24 and more accurate to sense and compare. The topology of
25 process block 68' can be defined as the algorithm

1 ADJUST FACTOR = $((A)/2^{(K)}) * (B)$

2 Where: A = the J-bit vector output from memory 62',

3 B = the K-bit vector output from latch 44', and

4 K = the number of bits used for the level code.

5

6 In this method, the adjustment is solely made for the
7 full-scale output current level, 111111, in this example. The
8 adjustment signal is determined for each row R in the display
9 and stored in memory 62'. The adjustment signal applied to the
10 adjustment I-DAC 69' is scaled by processor 68', based on the
11 aforementioned adjust factor equation and the value appearing
12 at the output of master latch 44'.

13

14 Thus, a new and improved programmable current source that
15 provides matched currents at multiple outputs is described. A
16 variety of calibration techniques can be used with the new and
17 improved programmable current source to provide matched or
18 substantially matched currents at multiple outputs. Here it
19 will be understood that not all of the methods described
20 provide adjustments for exact matching of all pixels for all
21 levels of luminance but all of the methods described provide
22 multiple outputs that are more closely matched than any known
23 prior art circuits, structures, or devices. The multiple
24 programmable current source can relatively easily be
25 incorporated with virtually any circuitry requiring multiple

1 constant current outputs and is relatively easy and inexpensive
2 to integrate on a single chip.

3
4 Various changes and modifications to the embodiment herein
5 chosen for purposes of illustration will readily occur to those
6 skilled in the art. For example, while the described
7 calibration methods use specific levels other or additional
8 levels could be used, fewer rows of pixels could be involved in
9 the calibration methods, depending on the specific application
10 or applications for which is intended to be employed. To the
11 extent that such modifications and variations do not depart
12 from the spirit of the invention, they are intended to be
13 included within the scope thereof.

14
15 Various changes and modifications to the embodiments
16 herein chosen for purposes of illustration will readily occur
17 to those skilled in the art. To the extent that such
18 modifications and variations do not depart from the spirit of
19 the invention, they are intended to be included within the
20 scope thereof which is assessed only by a fair interpretation
21 of the following claims.

22
23 Having fully described the invention in such clear and
24 concise terms as to enable those skilled in the art to
25 understand and practice the same, the invention claimed is: